

TPC Response Simulation Overview

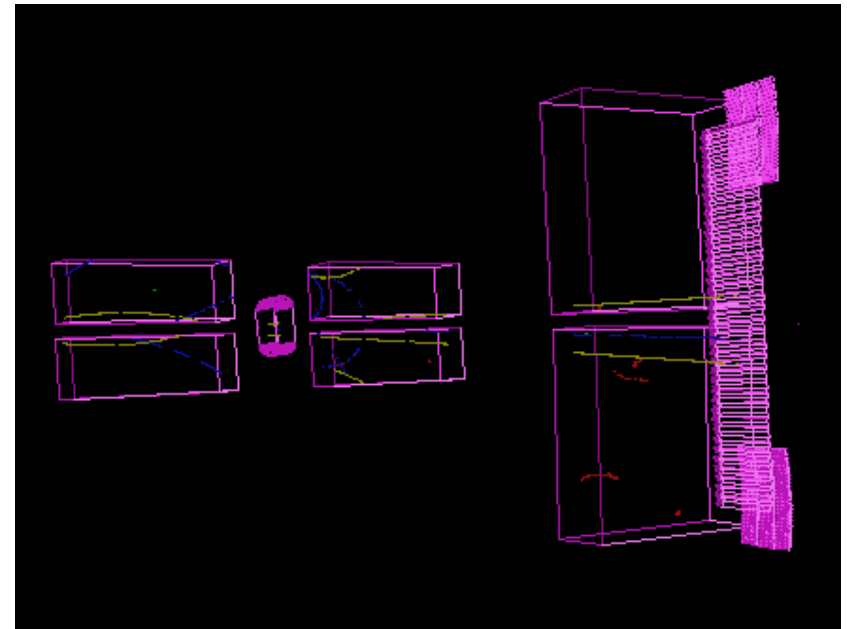
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7/1/15

Outline

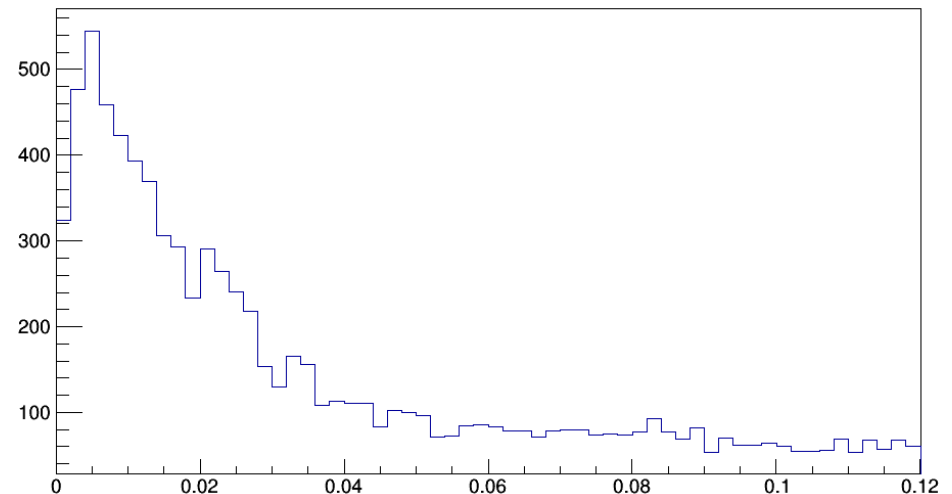
- Geant4 hits
- Drifting
 - Linear (MTPCs, FTPCs)
 - ExB (VTPCs, GTPC)
- Sample Generation
 - Sampling Resolution
 - Diffusion (X, Y)
 - Sample placement (Z)
- Response Simulation
 - Electrons Generated
 - Pad response/resolution (x, t)
 - Pad ADC values

Input: Geant4 Hits

- Provided information:
 - Global hit location (x,y,z)
 - Time of hit
 - Energy deposited
 - Particle momentum at hit
- Small step size between hits

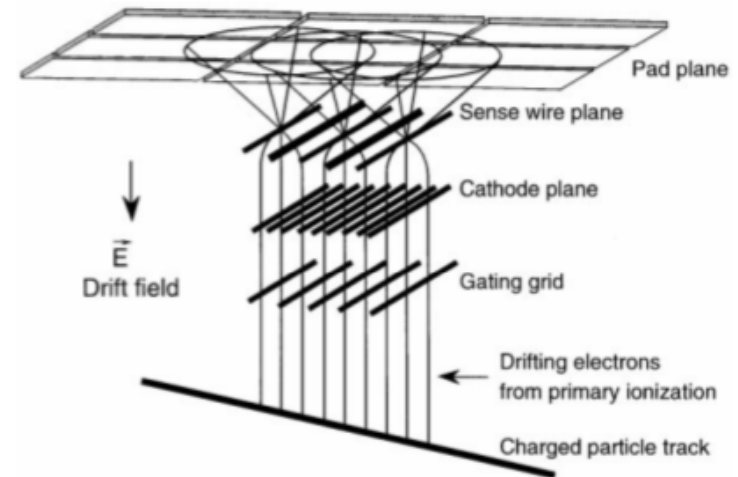


Distance Between Hits (cm)



Linear Drifting

- MTPCL/R, GTPC
- Electric field assumed to be homogeneous, vertical
- Drift velocities $\sim 1\text{-}2$ cm/ μs
 - MTPC drift length: up to 111 cm $\rightarrow \sim 80$ μs !
 - Data acquisition for only 51.2 μs (256 x 200 ns or 512 x 100 ns)



Crossed E, B Field Drifting

- Non-negligible B-field distortions in VTPC1/2, GTPC

$$m \frac{d\mathbf{v}}{dt} = e \mathbf{E} + e [\mathbf{v} \times \mathbf{B}] - K \mathbf{v}$$

$t \gg \tau$:

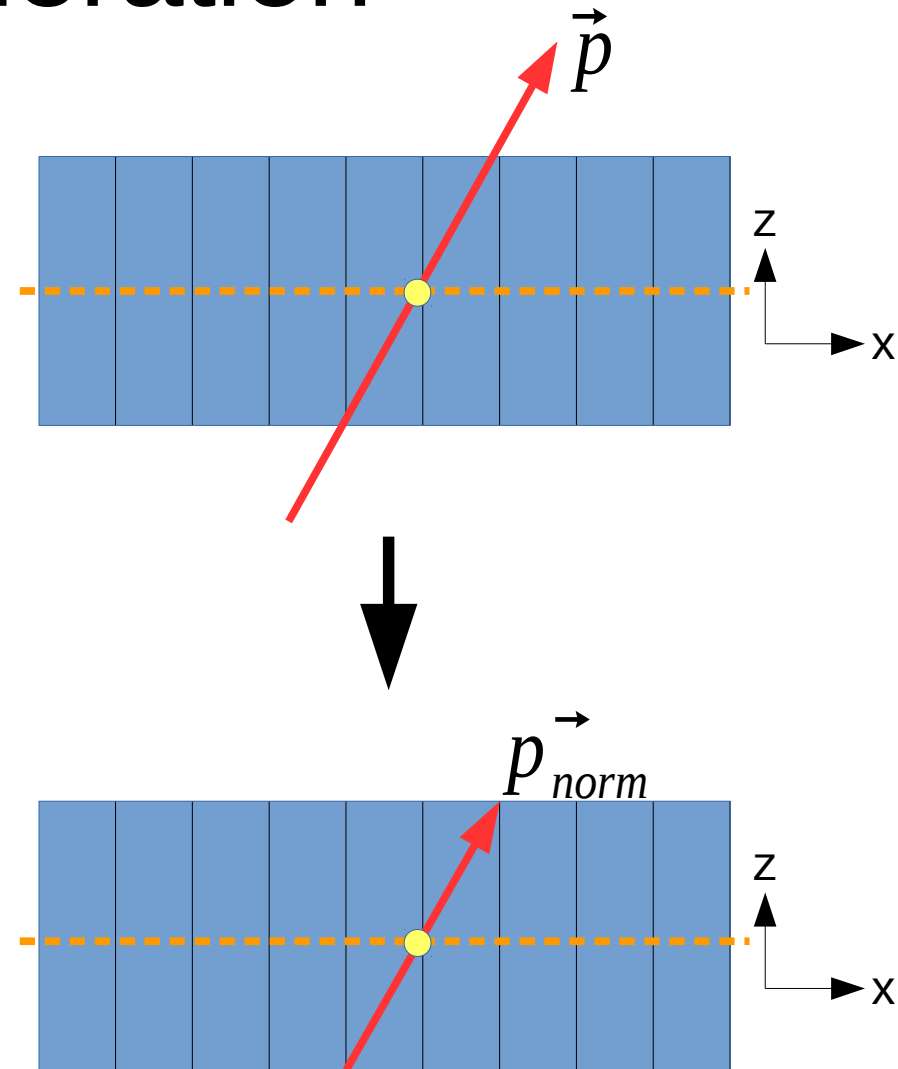
$$\frac{d\mathbf{r}}{dt} = \frac{-v_{drift}}{|\mathbf{E}|} \frac{1}{1 + (\omega\tau)^2} \left(\mathbf{E} + \frac{\omega\tau}{|\mathbf{B}|} [\mathbf{E} \times \mathbf{B}] - \left(\frac{\omega\tau}{|\mathbf{B}|}\right)^2 (\mathbf{E} \cdot \mathbf{B}) \mathbf{B} \right)$$

- Solve Langevin Eq. In this region using 5th-order Runge-Kutta (~1000 steps)

$$\tau = \frac{m}{K}, \quad \omega = \frac{e|\mathbf{B}|}{m}$$

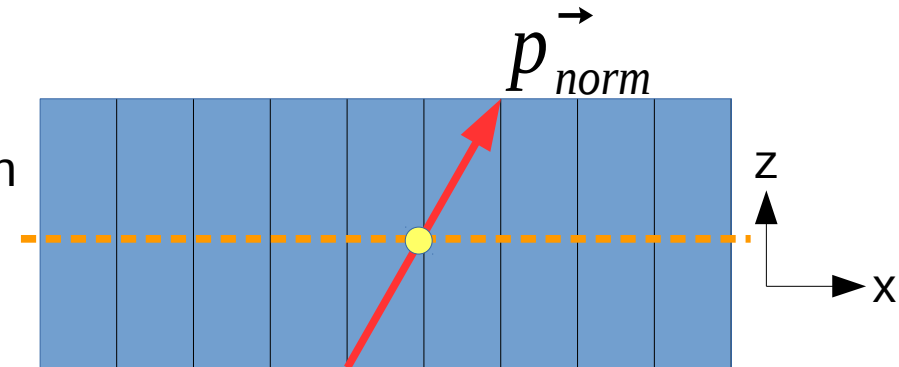
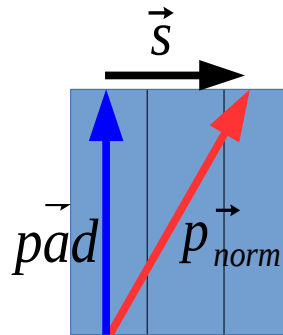
Sample Generation

- Drift positions at wire planes re-centered over padrows in order to create “energy deposition paths”
- Momentum normalized to pad length (z)



Sample Generation

- Signal Spread Length $|\vec{s}|$: Difference between normalized momentum vector and pad direction vector



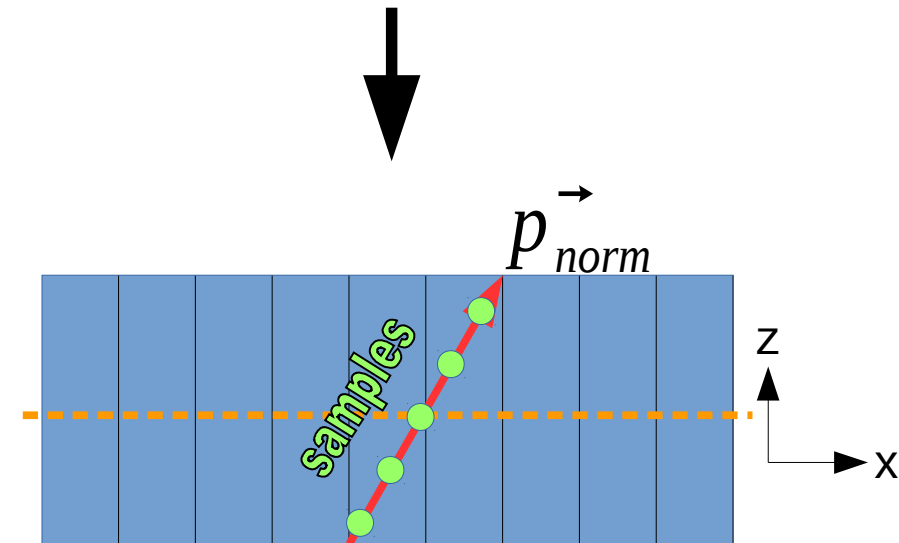
- Sampling Resolution R: largest of these two!
(Note: diffusion constant units in config file are $cm^{1/2}$!)

$$X_{samp} = 2 \sqrt{x_{resolution}^2 + x_{radius}^2} \quad x_{radius} = \sigma_{x-diff} \sqrt{d}$$

$$Y_{samp} = 2 \sqrt{y_{resolution}^2 + y_{radius}^2} \quad y_{radius} = \sigma_{y-diff} \sqrt{d}$$

- Number of Samples:

$$n_{samp} = 1 + \frac{|\vec{s}|}{R}$$



Response Simulation

- For each sample: $n_{electrons} = 1 + \left(\frac{n_{elec}}{Z_{unit}} \right) \left(\frac{|\vec{pad}|}{n_{samp}} \right)$,

$$n_{pads} = 2 \frac{\sigma_x}{|\vec{pad}|}$$

$\left(\frac{n_{elec}}{Z_{unit}} \right)$ Is a configuration parameter. Reasonable values?

- X-response σ_x :

$$\sigma_x = \sqrt{\sigma_{x-intrins}^2 + \sigma_{x-diff}^2 + \sigma_{x-cross}^2 + \sigma_{Lorentz}^2}$$

- Affects number of pads signal is distributed over

- X-resolution r_x :

$$r_x = \sqrt{r_{x-intrins}^2 + \frac{\sigma_{x-diff}^2}{n_{elec}} + \frac{r_{x-cross}^2 n_{samp}}{eff_{pad}} + r_{Lorentz}^2}$$

- Affects adjusted sample x-position

- Y-response σ_y :

$$\sigma_y = \sqrt{\sigma_{y-intrins}^2 + \sigma_{y-diff}^2 + \sigma_{y-cross}^2}$$

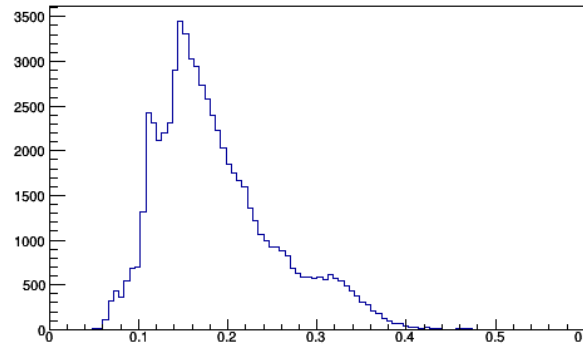
- Affects number of time bins signal is distributed over

- Y-resolution r_y :

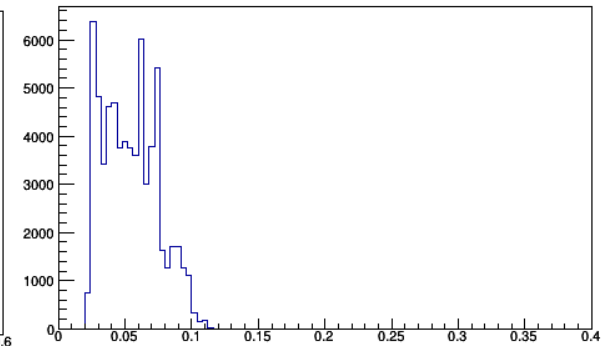
$$r_y = \sqrt{r_{y-intrins}^2 + \frac{\sigma_{y-diff}^2 n_{pads}}{n_{elec}} + \frac{\sigma_{y-cross}^2 n_{samp} n_{pads}}{eff_{pad}}}$$

- Affects central time bin (effectively sample y-position)

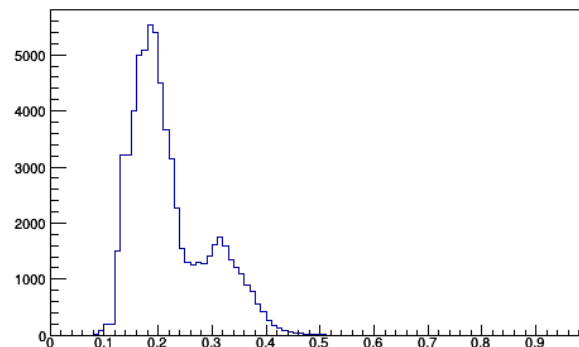
X-Response: (cm)



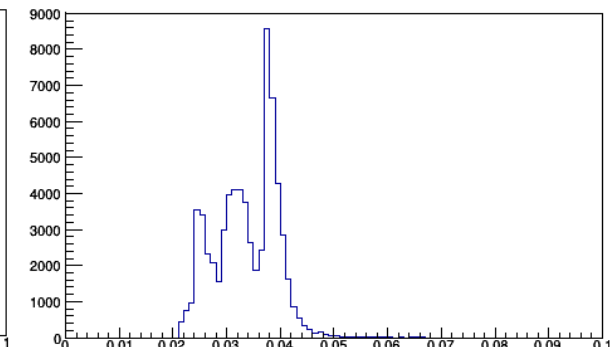
X-Resolution: (cm)



Y-Response: (cm)

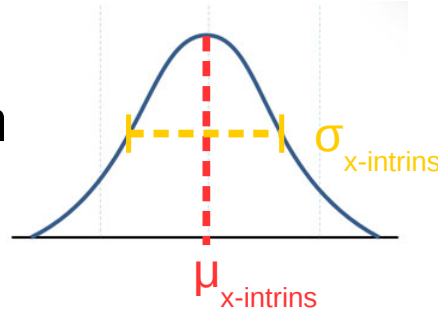


Y-Resolution: (cm)



Response Simulation

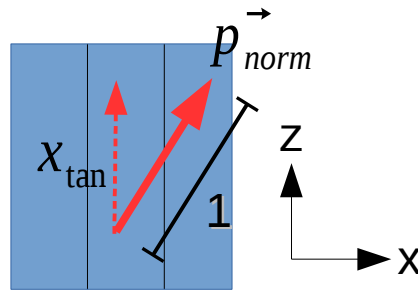
- $\sigma_{x-intrins}$:
Randomly selected from
distribution



- $r_{x-intrins} = \mu_{x-intrins}$

- σ_{x-diff} :
Diffusion coefficient

- $\sigma_{x-cross} = \frac{1}{12} \left(\frac{|p_{\vec{ad}}| x_{tan}}{n_{samp}} \right)^2$, $x_{tan} = (p_{norm}^{\vec{}}) \cdot \hat{x}$



- $r_{x-cross} = \sigma_{x-cross} \left(\frac{n_{samp}}{eff_{pad}} \right)$

- $\sigma_{Lorentz} = \frac{\gamma^2}{12(1+x_{tan}^2)}$

- $r_{Lorentz} = \frac{\gamma^2}{12(eff_{wire} n_{wires})(1+\tan(BA)^2)}$

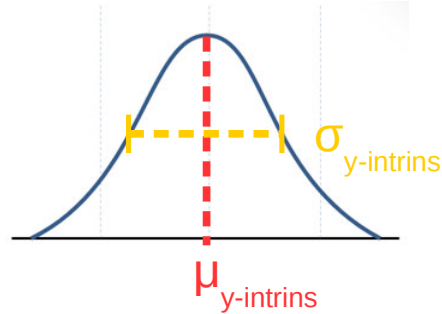
- $\gamma^2 = (p(x_{tan} - \theta_{Lorentz}))^2$

- $\tan(BA) = \frac{x_{tan-corr} - x_{tan}}{1 + x_{tan-corr} x_{tan}}$

- $x_{tan-corr}$ = corrected x_{tan} due to global pad tilt
- p = sense wire pitch
- $\theta_{Lorentz}$ = sector config parameter

Response Simulation

- $\sigma_{y-intrins}$:
Randomly selected from
distribution

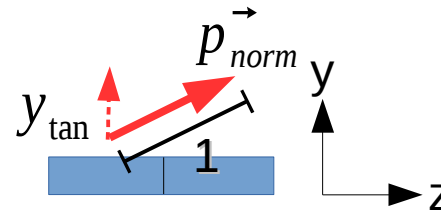


- $r_{y-intrins} = \mu_{y-intrins}$

- σ_{y-diff} :
Diffusion coefficient

No Lorentz Angle
corrections for
y-response /
y-resolution!

- $\sigma_{y-cross} = \frac{1}{12} \left(\frac{|p_{pad}| y_{tan}}{n_{samp}} \right)^2$, $y_{tan} = (\vec{p}_{norm}) \cdot \hat{y}$



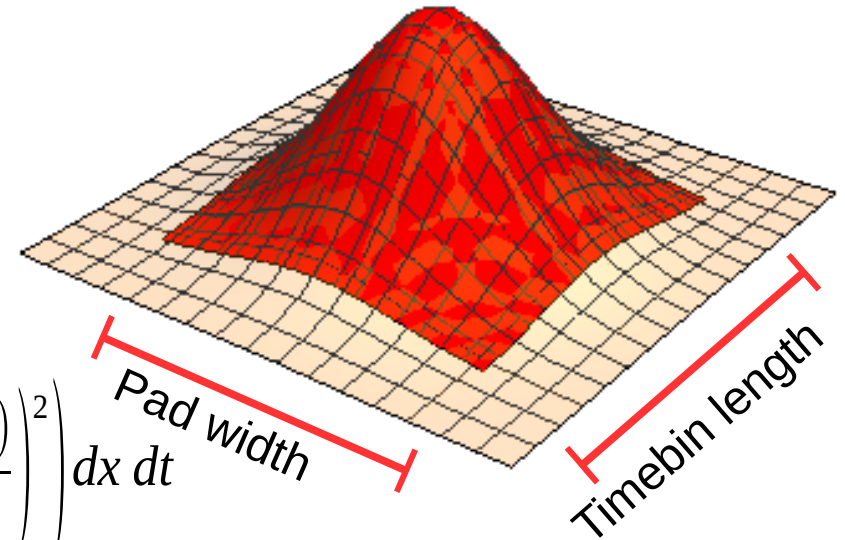
- $r_{y-cross} = \sigma_{y-cross} \left(\frac{n_{samp}}{eff_{pad}} \right)$

Unknown parameters!!
(eff_{pad} , eff_{wire})

Response Simulation

- ADC values written to pads:
Integral of 2-D Gaussian in
(x,t)

$$PadADC = adc \cdot \int_{-w/2}^{w/2} \int_{-T/2}^{T/2} \exp\left(-\left(\frac{\Delta x}{r_x}\right)^2\right) \exp\left(-\left(\frac{(\Delta y/v_d)}{(r_y/v_d)}\right)^2\right) dx dt$$



- w = pad width
- T = timebin length
- Δx , Δy = distance from sample center (pad farther from sample center receives smaller ADC value)
- adc = ADC/dE factor (see next slide)
- X and Y resolution (r_x , r_y) are used to slightly shift final sample positions before ADC value calculation
- Pads within $3\sigma_x$ (x-response width) are written to

ADC Value Calculation

- Minimal dE Along Pad: Another integral over the same 2-D Gaussian, multiplied by pad length and a *factor*:
 - “MinimalDEPerLengthUnit”
 - How to obtain this factor?
- Total ADC for Geant4 hit: Multiply ADC/dE factor by energy deposited, spread evenly among samples

$$\text{Min. } dE = \frac{\text{Min. } dE}{\text{pathLength}} \cdot |\vec{pad}| \cdot \int_{-w/2}^{w/2} \int_{-T/2}^{T/2} \exp\left(-\left(\frac{\Delta x}{r_x}\right)^2\right) \exp\left(-\left(\frac{(\Delta y/v_d)}{(r_y/v_d)}\right)^2\right) dx dt$$

$\frac{S}{N}$: Signal-to-noise ratio

$$\frac{ADC}{dE} = \left(\sigma_{noise} \frac{S}{N} \right) \left(\frac{1}{(\text{Min. } dE) g_{y0}} \right)$$

σ_{noise} : “Noise sigma”

g_{y0} Gain at local $y=0$ inside chamber

Thanks!